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An Experimental Approach to Characterising CAF

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NPL (National Physical Laboratory)

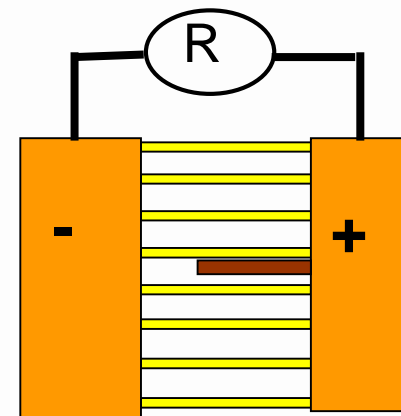
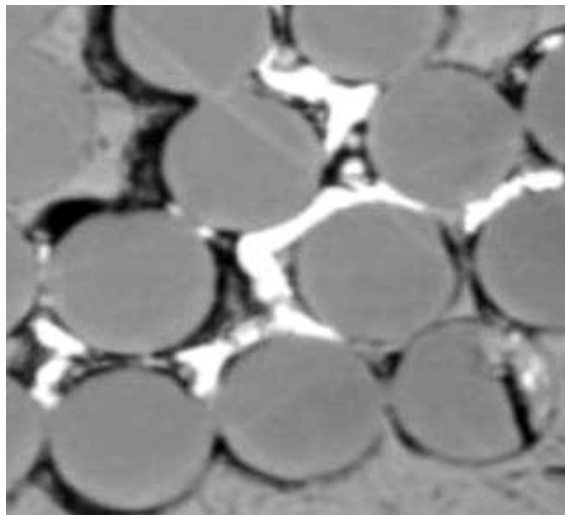
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- Isola
- Invotec
- MBDA
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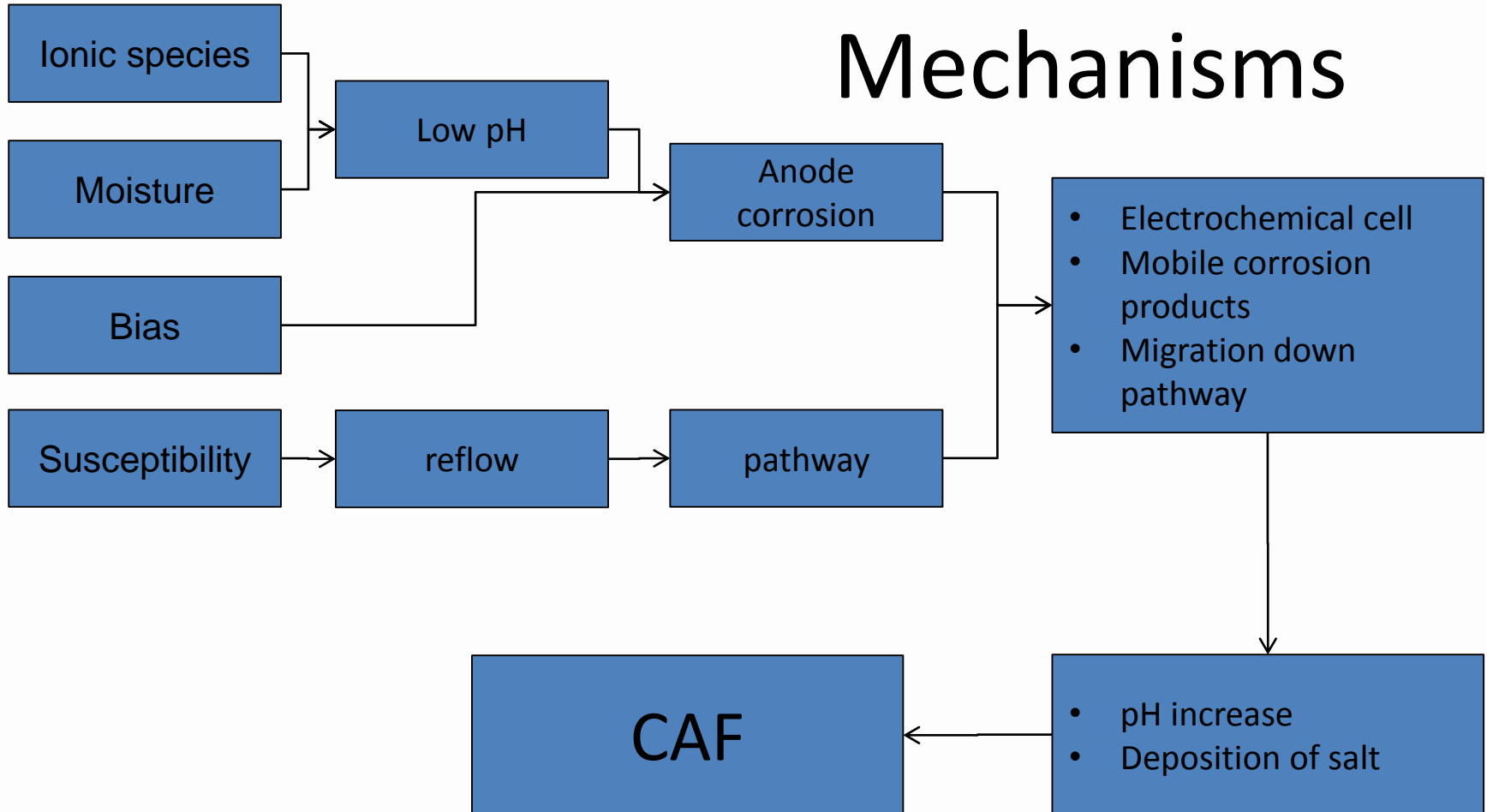
The National Measurement Office of the UK Department for Business, Innovation and Skills

Conductive Anode Filament (CAF)

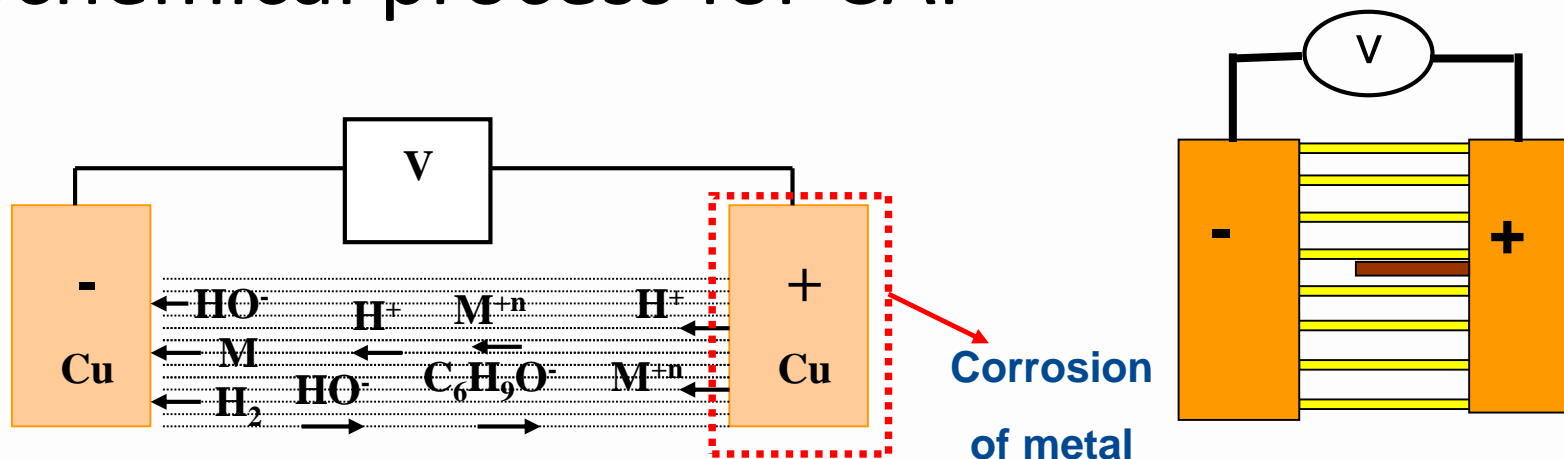
- CAF formation inside the PCB is an important failure mode for circuit assemblies. It is an electrochemical process, and initially caused by corrosion of Cu at the anode.
- CAF is where Cu corrosion products grow along the glass/resin interface from anode to cathode



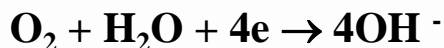
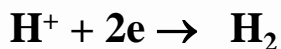
Mechanisms



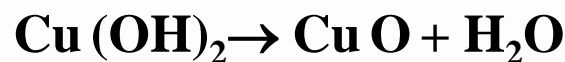
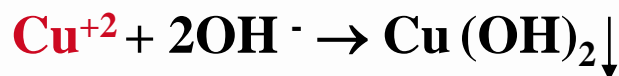
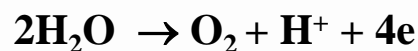
Electrochemical process for CAF



Cathode



Anode



CuO: Black CuCl₂: Yellow brown CuSO₄·5H₂O: Blue

Conditions for CAF formation

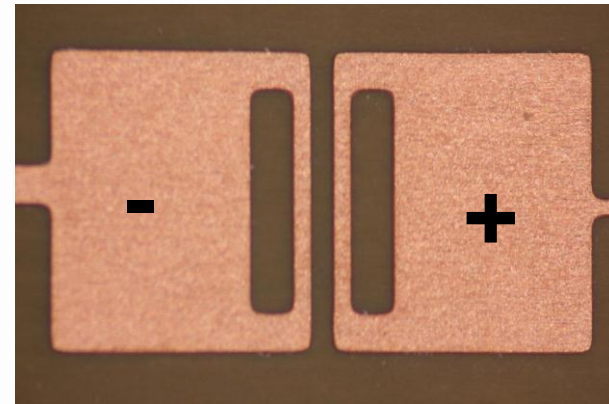
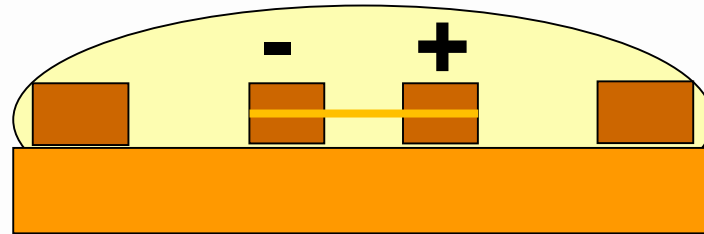
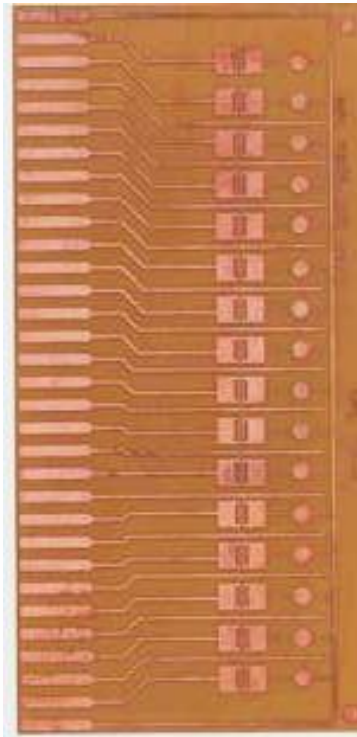
- Electrical charge carriers must be present to form electrochemical cell
 - Ionic species inside PCB, H^+ and OH^- from water
- Water must be present to dissolve the ionic material and sustain them in their mobile ionic state
 - Moisture, humidity
- Acid environment around conductors is needed to initiate Cu corrosion at anode.
 - Ionic contamination from resin, acid residues from plating process
- Pathway is needed for ions to move
 - Delamination between glass fibre and resin, due to reflow
- Bias acts as driving force for ion transport
 - Circuits need to be powered up in service

Simulated Test Vehicle (STV)

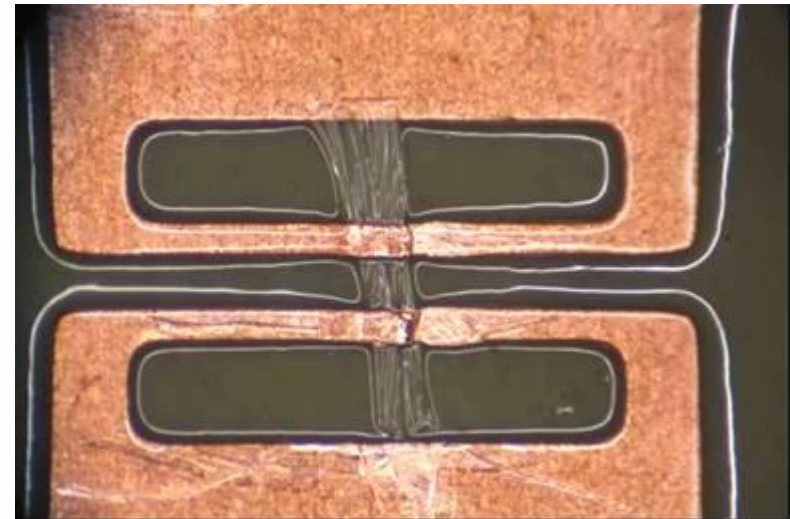
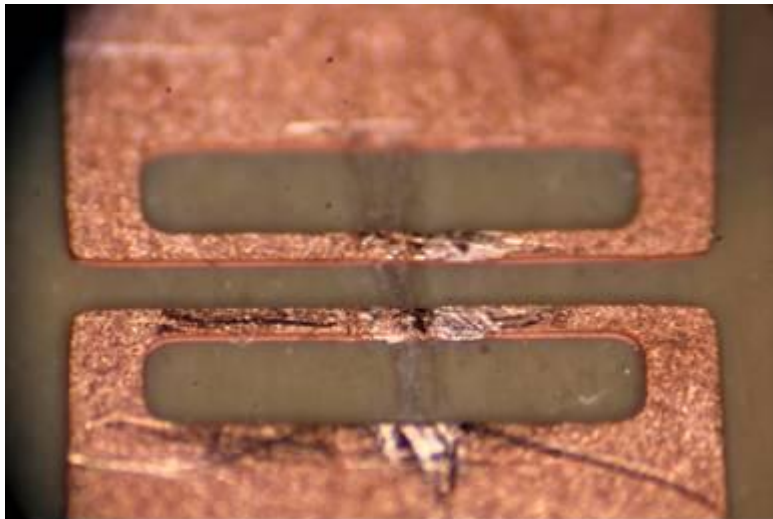
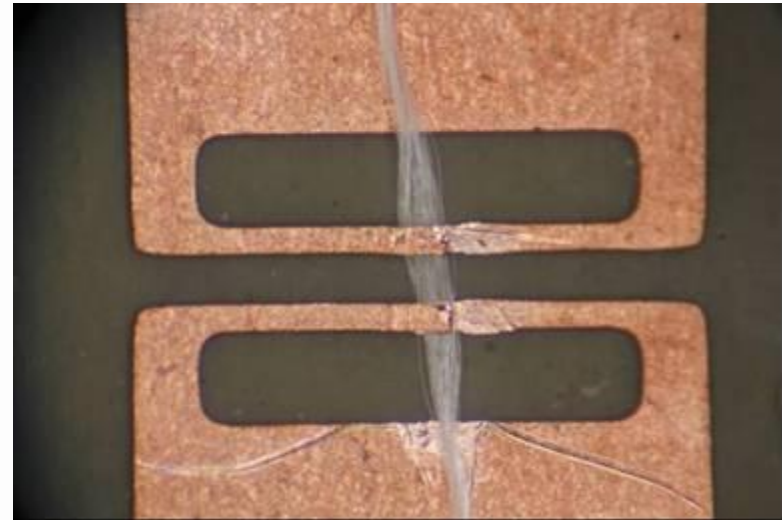
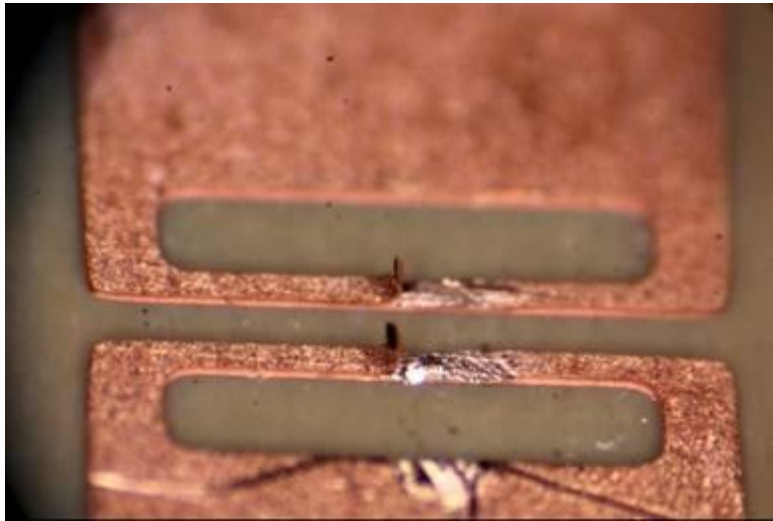
- Simulated Test Vehicle (STV1) was developed, which provides a controlled way to grow CAF.
- Enables the investigation of different variables separately.
- CAF formation:
 - Different resin systems and glass fibres
 - Reflow process
 - Desmear process: sample drilled
 - Glass bundle size
- CAF can be easily seen using microscope backlight



STV sample

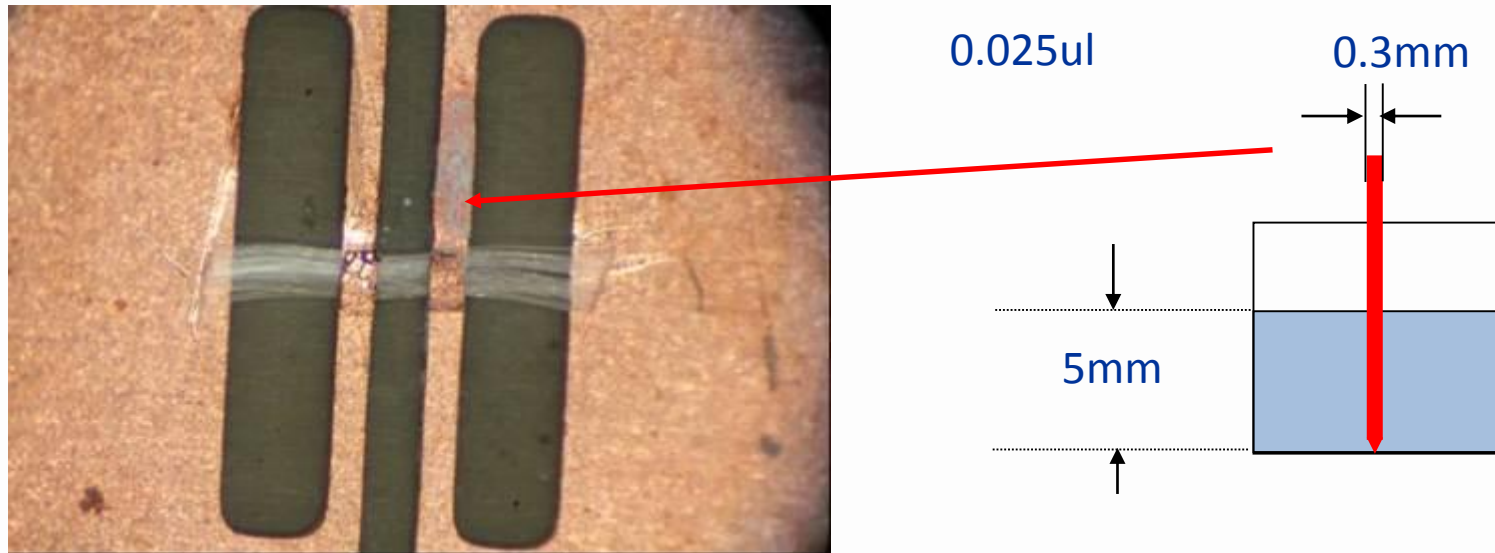


- Polyimide substrate with 2 oz Cu
- Resin powder dissolved in acetone
- Resin cured at 150°C for 60 minute




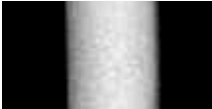



Test sample preparation

Different variables



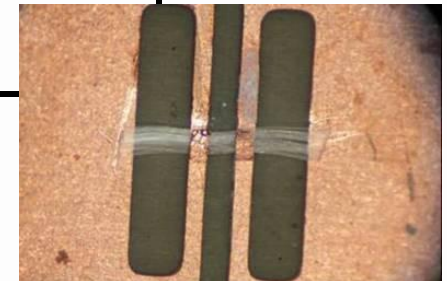
- Acid condition at anode (plating solution $\text{CuSO}_4 + \text{H}_2\text{SO}_4$)
- Ionic contamination inside PCB (contaminated fibres)
- Pathway between two conductors (Reflow process)

Test different resins and glass fibres

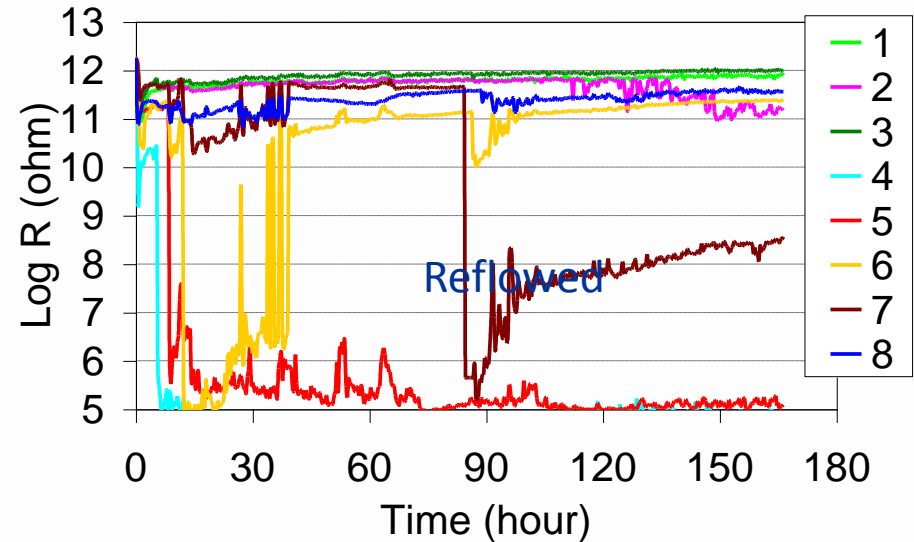
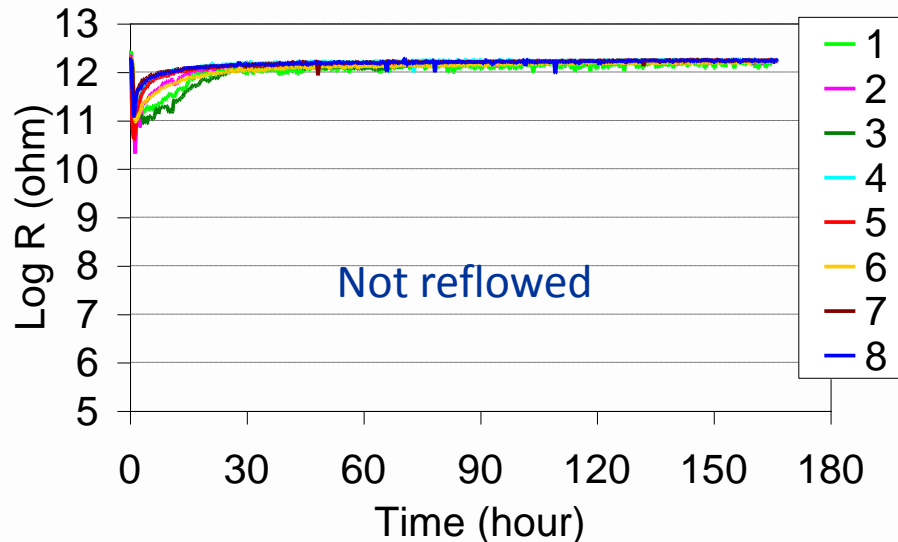
Resin	Glass fibres	Supplier
DICY Cured*	1080 finished 	A
	7628 finished 	
Phenolic cured	7628 finished 	B
	7628 heat cleaned no finish 	
	7628 loom state no finish 	

← 20μm →

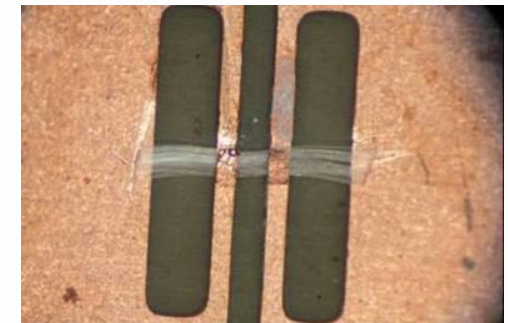
- Anode contamination (on / off)



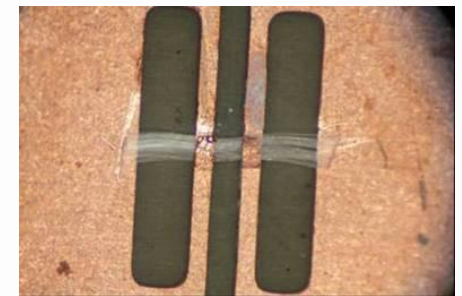
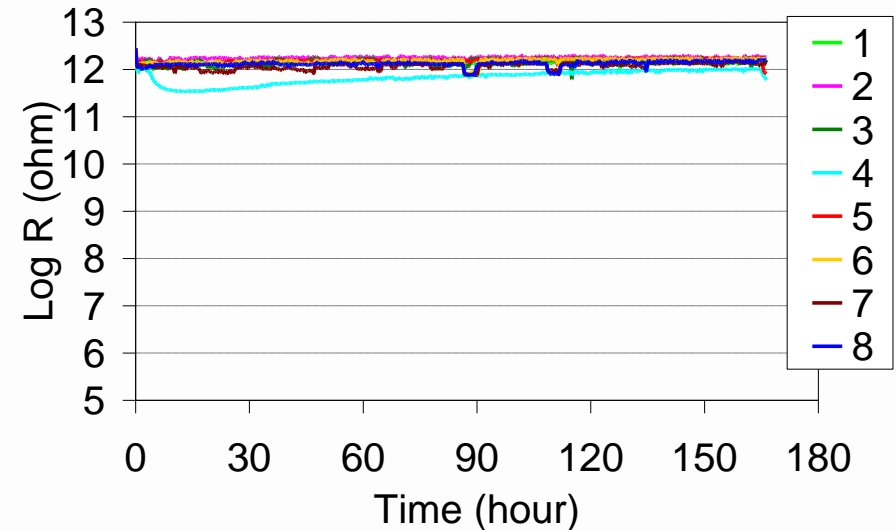
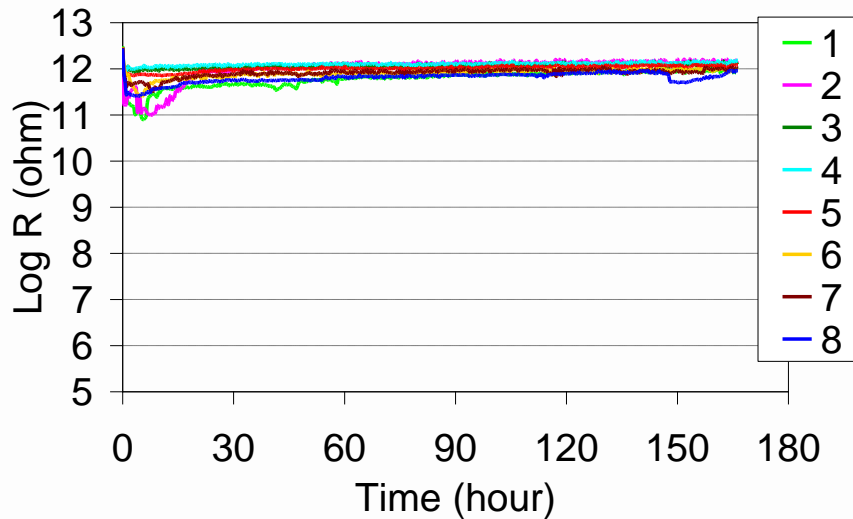
Phenolic cured resin - 7628 heat clean fibre



- Anode: no contamination
- Fibres: clean
- CAF formed on reflowed sample



Phenolic cured resin - 1080 finished fibre



- Anode: 100% plating solution
- Fibres: clean
- No CAF formed on both reflowed and no reflowed samples

CAF propensity

Anode contamination	Glass fibres	Resin	CAF formation	
			No Reflow	Reflowed
100% plating solution	1080 finish (A)	DICY Cured	×	×
	7628 finish (A)			
	7628 finish (B)			
	7628 heat cleaned		✓	
	7628 loom state			
None	7628 heat cleaned	DICY Cured		×
	7628 loom state			
	7628 heat cleaned		×	✓
	7628 loom state		✓	✓
100% plating solution	1080 finish (A)	Phenolic cured	×	×
	7628 finish (A)			
	7628 finish (B)			

Different resins and glass fibres

- With anode contamination only:
 - There is CAF formation for heat cleaned and loom state fibres with both resins (DICY and phenolic cured).
 - There is no CAF formation for all finished fibres with both resins.

Finished glass fibre - DICY resin

Anode	Fibre	Reflow
100% plating solution	3% NaCl	✓
20% plating solution		×
20% plating solution		✓
100% plating solution		×
100% plating solution	1% NaCl	✓
100% plating solution		×
20% plating solution		✓
20% plating solution		×

- Anode contamination
- Fibre coated in NaCl
- Reflow & no reflow

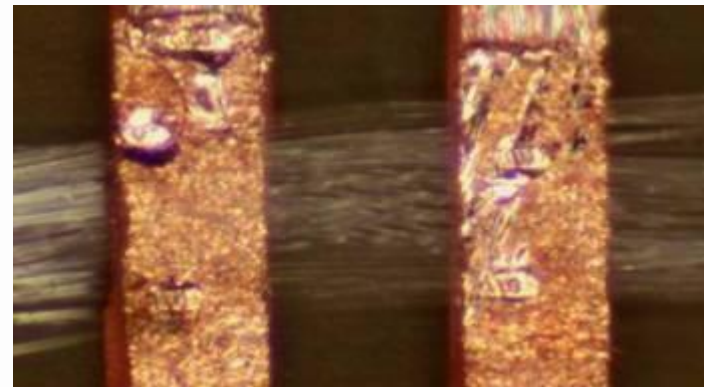
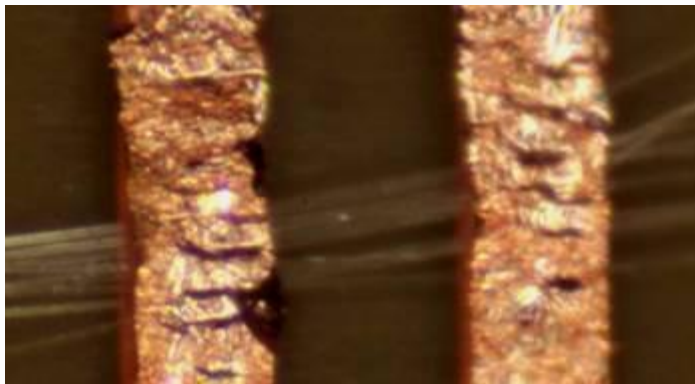


Conclusion for finished fibres

Anode	Fibre	Reflow	CAF formation
100% plating solution	3% NaCl	✓	✓
100% plating solution		×	×
20% plating solution		✓	✓
20% plating solution		×	×
100% plating solution	1% NaCl	✓	×
100% plating solution		×	×
20% plating solution		✓	×
20% plating solution		×	×

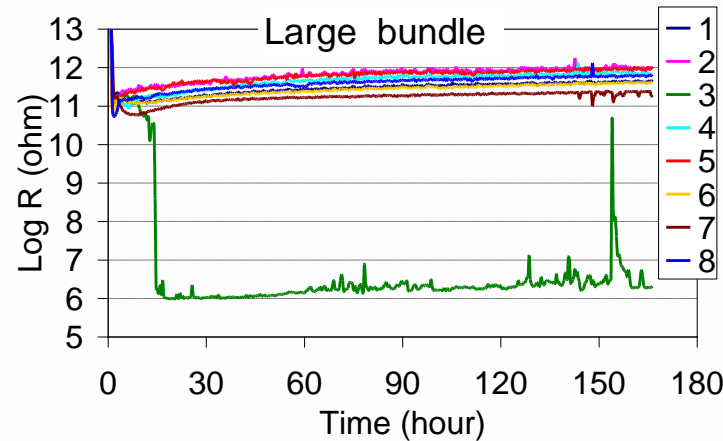
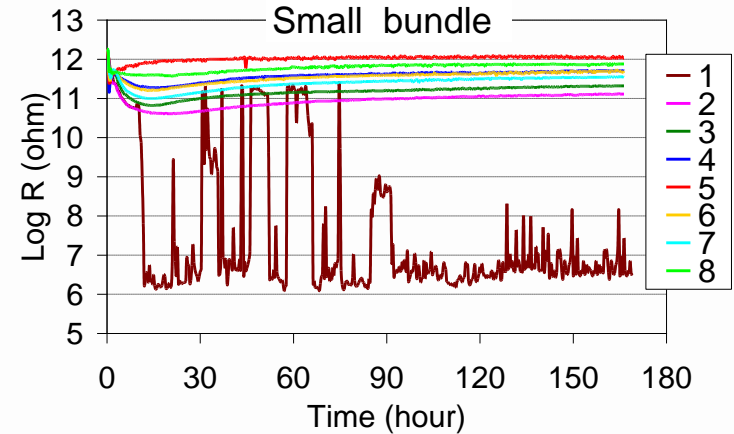
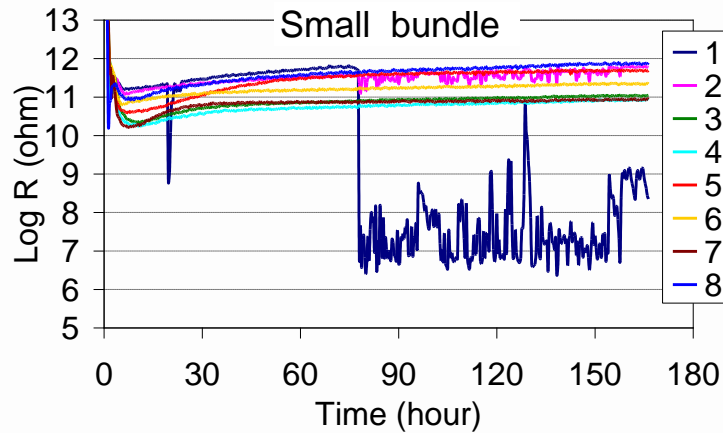
- Three factors must be met for CAF formation
 - Low pH at anode (Plating solution contamination)
 - Ionic contamination inside PCB (NaCl coated fibres)
 - Pathway between two conductors (Reflow process)

Different glass fibre bundle size

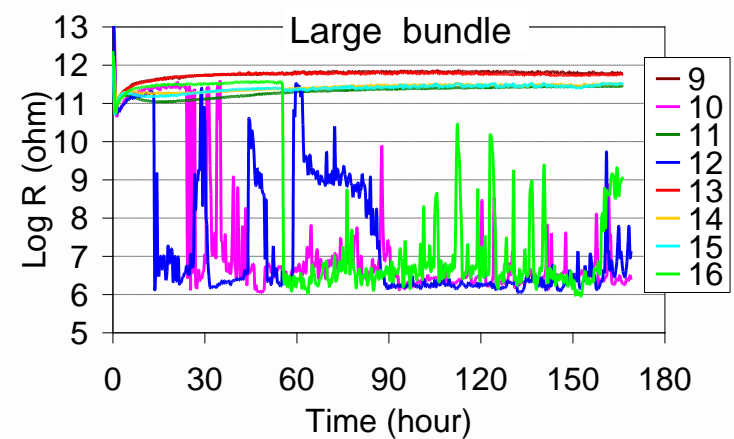


- Phenolic cured resin
- Anode: no contamination
- Fibres: Heat cleaned and loom state glass fibres
- Bundle size: small (~10) & large (30~50)
- Reflowed

Phenolic cured resin

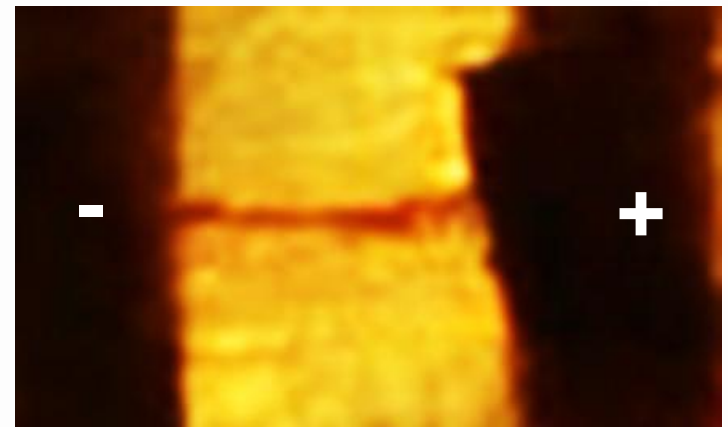
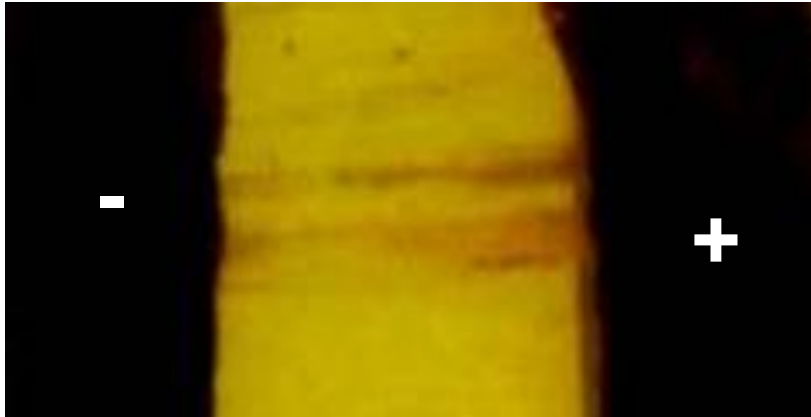


Heat cleaned fibre

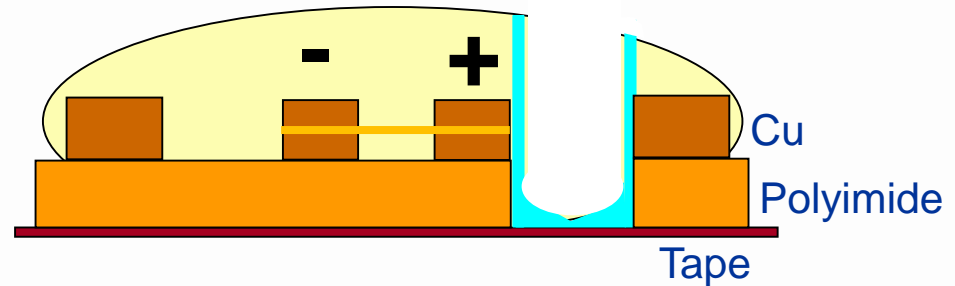
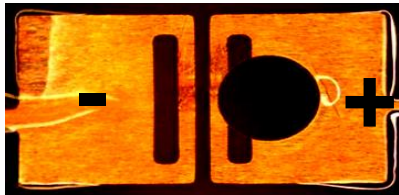


Loom state fibre

CAF formation



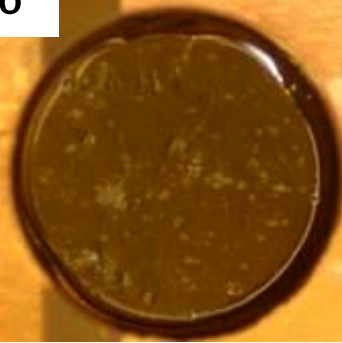
STV with drilled hole



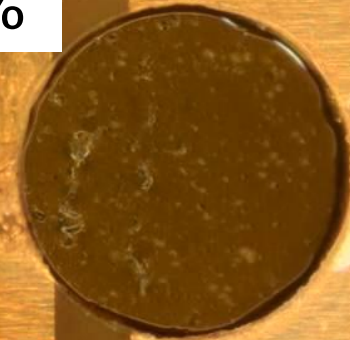
100%



30%

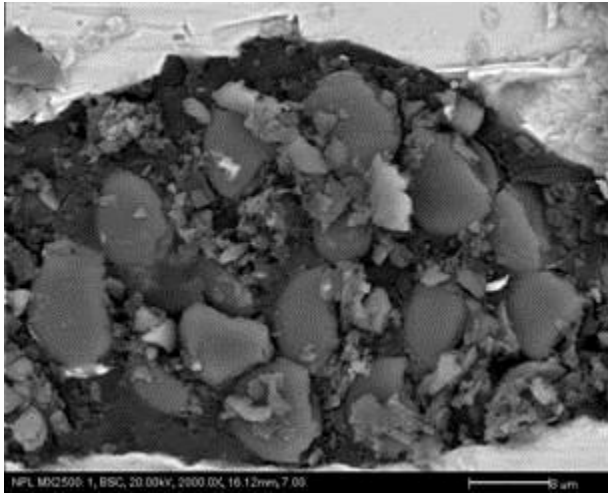


10%

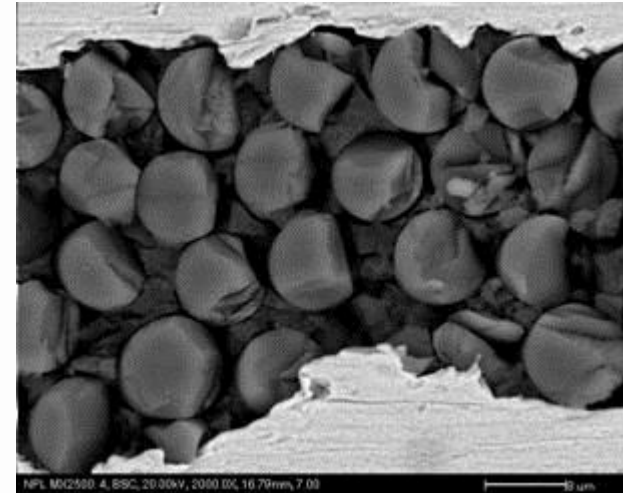


- STV placed on adhesive tape.
- Hole filled with 1 μ l different concentration plating solutions.
- Filling solution dried for 2 hours at room temperature before CAF testing.

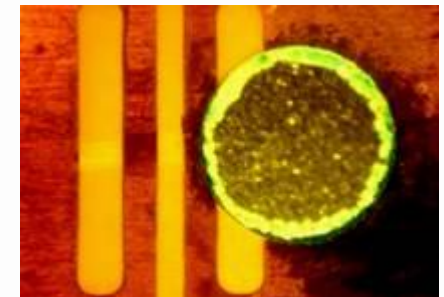
CAF formation – desmear process



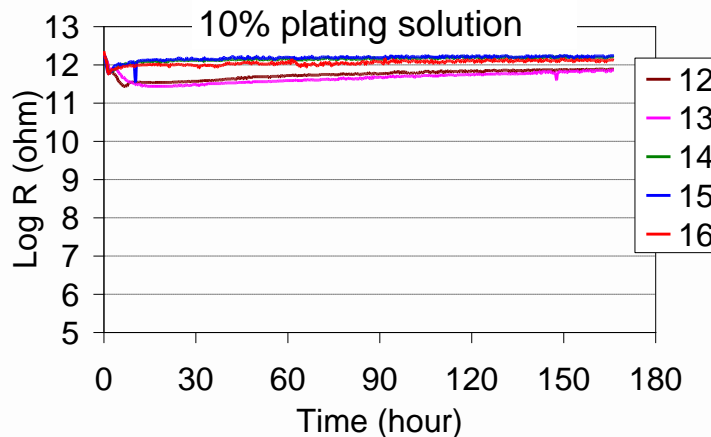
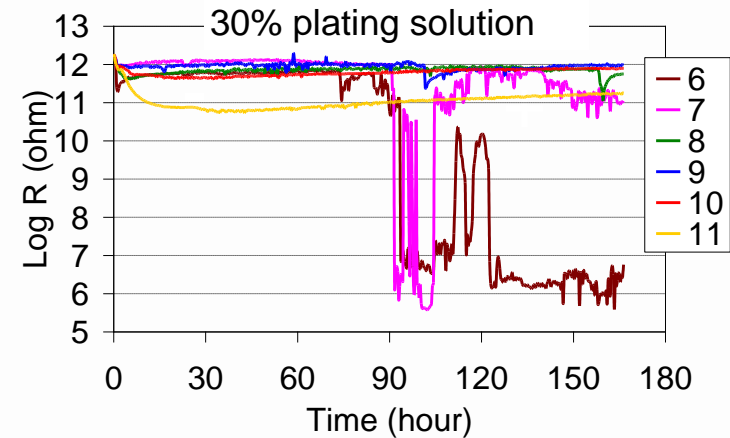
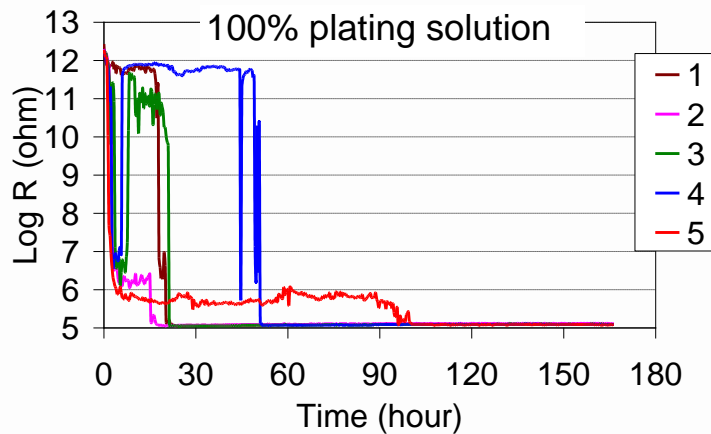
No-desmear



Desmeared

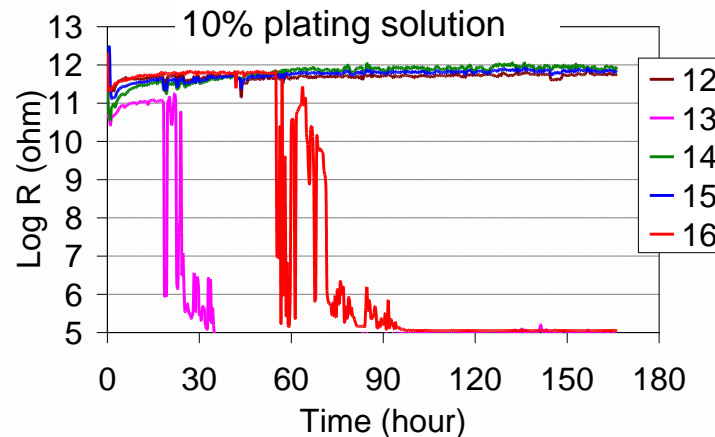
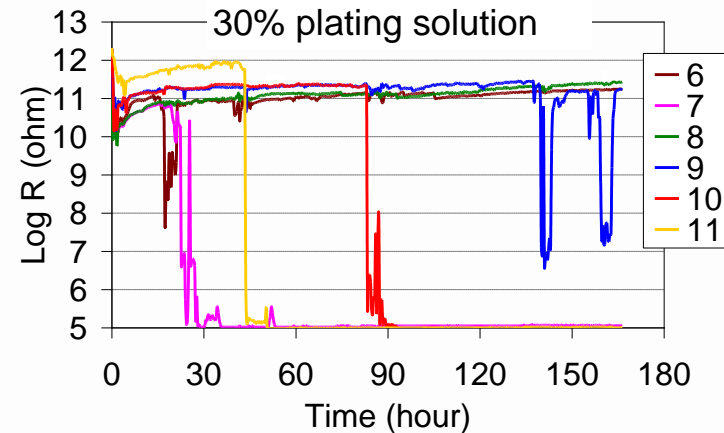
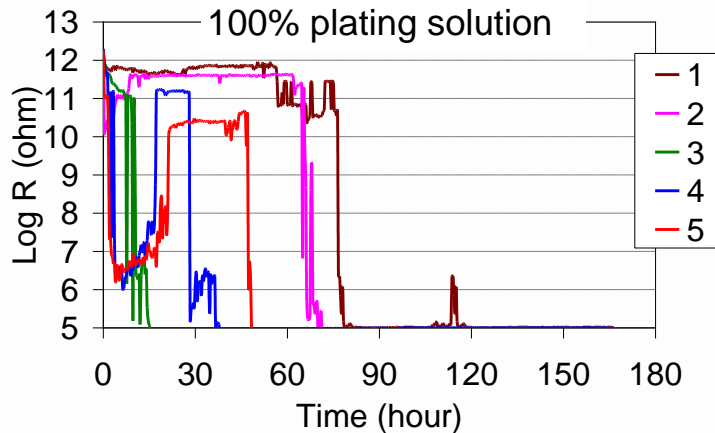


CAF formation without desmear



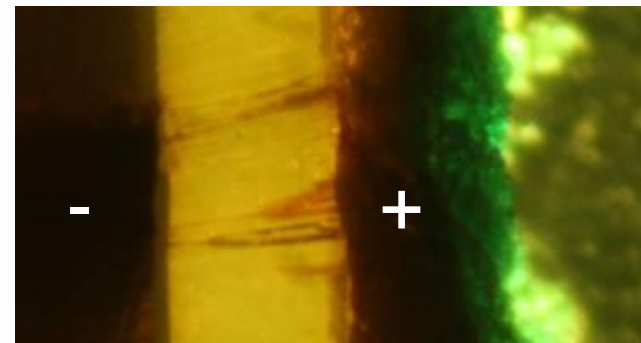
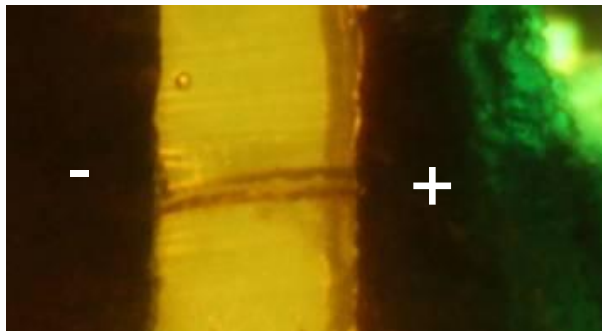
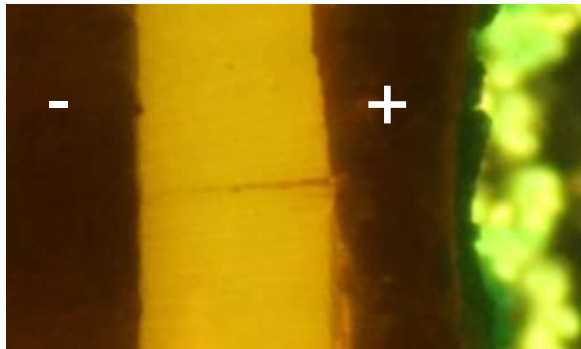
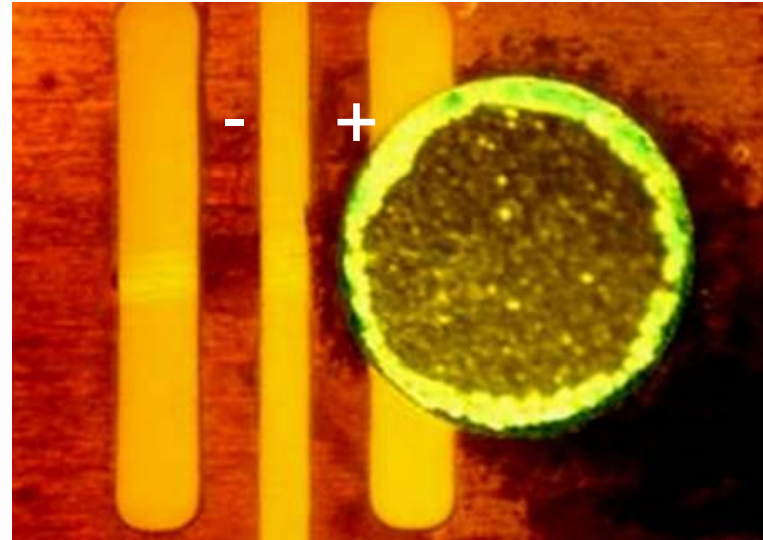
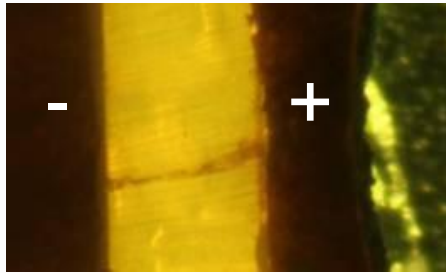
- Phenolic cured resin & 7628 finished glass fibre (B)
- More CAF formed with contamination increase

CAF formation with desmear

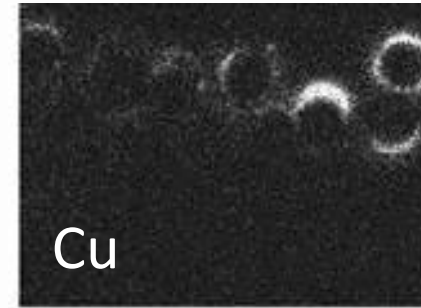
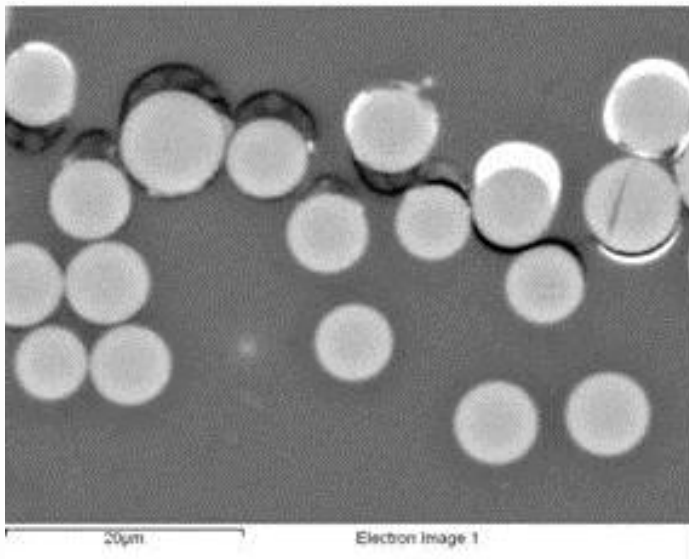
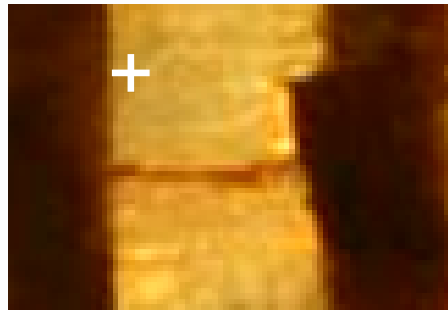


- Phenolic cured resin & 7628 finished glass fibre
- Desmear process increase CAF formation, but not significant.

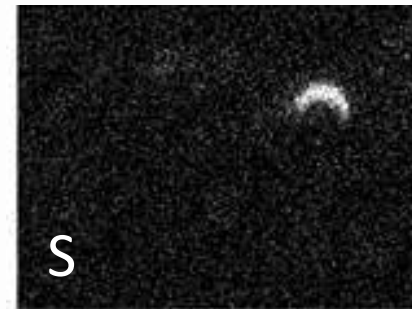
Examples of CAF growth in STV



CAF formation



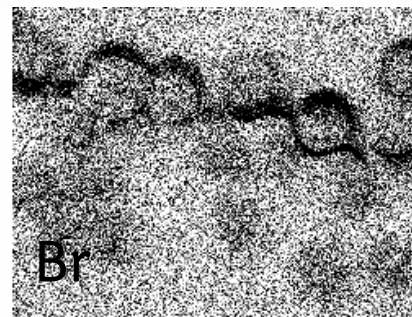
Cu Ka1



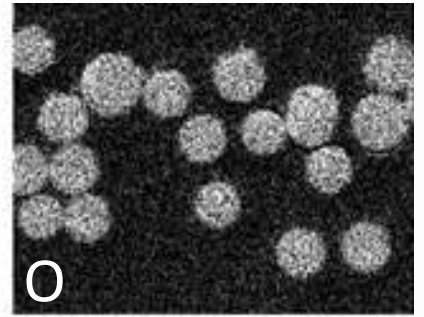
S Ka1



Cl Ka1



Br La1_2



O Ka1

Conclusions

- STV has been successfully used to evaluate the effect of different resin systems, different glass fibres, desmear process, reflow process and glass fibre bundle size on CAF failure.
 - Heat cleaned and loom state fibres form CAF more easily than finished fibres. Loom state fibre has the highest propensity to form CAF compared with others.
 - Phenolic cured resin promote more CAF than DICY cured resin, this is probably because the DICY was removed when the resin was dissolved in acetone in our sample preparation.
 - Desmear process can increase CAF formation, but not significant.
 - Reflow process increase CAF formation significantly.
 - Large bundle size increase CAF formation, but not significant.